EDT2 IGBT and emitter controlled diode in TO247PLUS package

Features

- V_{CE} = 750 V
- I_C = 120 A
- 750 V collector-emitter blocking voltage capability
- Suitable for 470 V V_{DC} systems and increase overvoltage margin for 400 V V_{DC} systems
- Very low $V_{CE(sat)}$, 1.30 V at I_{Cnom} = 120 A, 25°C
- Short circuit robust t_{sc} = 5 μs at V_{CE} = 470 V, V_{GE} = 15 V
- Self limiting current under short circuit condition
- Positive thermal coefficient and very tight parameter distribution for easy paralleling
- Drop-in replacement for previous generation devices I_C = 120 A, T_c = 100°C
- Excellent current sharing in parallel operation
- Smooth switching characteristics, low EMI signature
- Low gate charge Q_G
- Simple gate drive design
- Co-packed with fast soft recovery emitter controlled 3 diode
- TO247PLUS package with high creepage distance
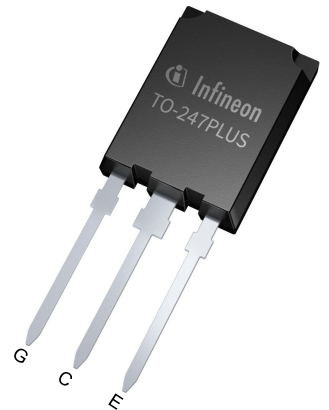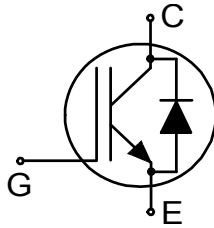- High reliability

Potential applications

- xEV traction inverter
- DC-link discharge switch
- Automotive aux-drives

Product validation

- Qualified for automotive applications
- Qualified according to AEC-Q101

Description

Type	Package	Marking
AIKQ120N75CP2	PG-TO247PLUS-3	AKQ12FCP

Please read the sections "Important notice" and "Warnings" at the end of this document

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1 Package

Table 1   **Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	**Typ.**	**Max.**	
Internal emitter inductance measured 5 mm (0.197 in) from case	L_E			13.0		nH
Storage temperature	T_{stg}		-55		150	°C
Soldering temperature		wave soldering 1.6 mm (0.063 in.) from case for 10 s			260	°C
Thermal resistance, junction-ambient	$R_{th(j-a)}$				40	K/W

2 IGBT

Table 2   **Maximum rated values**

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CE}			750	V
DC collector current, limited by T_{vjmax}	I_C	$T_c = 25\ °C$		150	A
		$T_c = 100\ °C$		120	
Pulsed collector current, t_p limited by T_{vjmax}	I_{Cpulse}			360	A
Turn-off safe operating area		$V_{CE} \leq 750\ V$, $t_p = 1\ \mu s$, $T_{vj} \leq 175\ °C$		360	A
Gate-emitter voltage	V_{GE}			±20	V
Transient gate-emitter voltage	V_{GE}	$t_p < 0.1\ \mu s$, $D < 0.01$		±30	V
Short-circuit withstand time	t_{SC}	$V_{CC} \leq 470\ V$, $V_{GE} = 15\ V$, Allowed number of short circuits < 1000, Time between short circuits ≥ 1.0 s, $T_{vj} = 25\ °C$		5	μs
Power dissipation	P_{tot}	$T_c = 25\ °C$		682	W
		$T_c = 100\ °C$		341	

Table 3   **Characteristic values**

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	**Typ.**	**Max.**	
Collector-emitter saturation voltage	V_{CEsat}	$I_C = 120\ A$, $V_{GE} = 15\ V$	$T_{vj} = 25\ °C$		1.3	1.5	V
			$T_{vj} = 175\ °C$		1.53		
Gate-emitter threshold voltage	V_{GEth}	$I_C = 1.6\ mA$, $V_{CE} = V_{GE}$, $T_{vj} = 25\ °C$		5	5.8	6.5	V

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Zero gate-voltage collector current	I_{CES}	V_{CE} = 750 V, V_{GE}=0 V	T_{vj}=25 °C			200	µA
			T_{vj}=175 °C		4000		
Gate-emitter leakage current	I_{GES}	V_{CE}=0 V, V_{GE}=20 V				100	nA
Transconductance	g_{fs}	I_C = 120 A, V_{CE}=20 V			90		S
Short-circuit collector current	I_{SC}	V_{CC} ≤ 470 V, V_{GE}=15 V, t_{SC} ≤ 5 µs, Allowed number of short circuits < 1000 , Time between short circuits ≥ 1.0 s, T_{vj}=25 °C			750		A
Input capacitance	C_{ies}	V_{CE}=25 V, V_{GE}=0 V, f=100 kHz			13125		pF
Output capacitance	C_{oes}	V_{CE}=25 V, V_{GE}=0 V, f=100 kHz			337		pF
Reverse transfer capacitance	C_{res}	V_{CE}=25 V, V_{GE}=0 V, f=100 kHz			59		pF
Gate charge	Q_G	I_C = 120 A, V_{GE}=15 V, V_{CC} = 600 V, V_{CE}=600 V			731		nC
Turn-on delay time	t_{don}	V_{CE} = 470 V, V_{GE} = -8/15 V, R_{Gon} = 5 Ω, R_{Goff} = 5 Ω, L_σ=50 nH, C_σ=30 pF	T_{vj} = 25 °C, I_C = 120 A		71		ns
			T_{vj} = 175 °C, I_C = 120 A		50		
Rise time (inductive load)	t_r	V_{CE} = 470 V, V_{GE} = -8/15 V, R_{Gon} = 5 Ω, R_{Goff} = 5 Ω, L_σ=50 nH, C_σ=30 pF	T_{vj} = 25 °C, I_C = 120 A		69		ns
			T_{vj} = 175 °C, I_C = 120 A		68		
Turn-off delay time	t_{doff}	V_{CE} = 470 V, V_{GE} = -8/15 V, R_{Gon} = 5 Ω, R_{Goff} = 5 Ω, L_σ=50 nH, C_σ=30 pF	T_{vj} = 25 °C, I_C = 120 A		244		ns
			T_{vj} = 175 °C, I_C = 120 A		226		
Fall time (inductive load)	t_f	V_{CE} = 470 V, V_{GE} = -8/15 V, R_{Gon} = 5 Ω, R_{Goff} = 5 Ω, L_σ=50 nH, C_σ=30 pF	T_{vj} = 25 °C, I_C = 120 A		50.5		ns
			T_{vj} = 175 °C, I_C = 120 A		67		
Turn-on energy[1]	E_{on}	V_{CE} = 470 V, V_{GE} = -8/15 V, R_{Gon} = 5 Ω, R_{Goff} = 5 Ω, L_σ=50 nH, C_σ=30 pF	T_{vj} = 25 °C, I_C = 120 A		6.82		mJ
			T_{vj} = 175 °C, I_C = 120 A		7.3		
Turn-off energy	E_{off}	V_{CE} = 470 V, V_{GE} = -8/15 V, R_{Gon} = 5 Ω, R_{Goff} = 5 Ω, L_σ=50 nH, C_σ=30 pF	T_{vj} = 25 °C, I_C = 120 A		3.8		mJ
			T_{vj} = 175 °C, I_C = 120 A		4.7		

(table continues...)

Table 3   **(continued) Characteristic values**

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Total switching energy	E_{ts}	V_{CE} = 470 V, V_{GE} = -8/15 V, R_{Gon} = 5 Ω, R_{Goff} = 5 Ω, L_σ=50 nH, C_σ=30 pF	T_{vj} = 25 °C, I_C = 120 A		10.3		mJ
			T_{vj} = 175 °C, I_C = 120 A		12.1		
IGBT thermal resistance, junction to case[2]	R_{thjc}				0.17	0.22	K/W
Operating junction temperature	T_{vj}			-40		175	°C

[1]   Includes reverse recovery losses
[2]   Not subject to production test - specified by simulation.

3   Diode

Table 4   **Maximum rated values**

Parameter	Symbol	Note or test condition		Values	Unit
Diode forward current, limited by T_{vjmax}	I_F		T_C = 25 °C	150	A
			T_C = 100 °C	120	
Diode pulsed current, limited by T_{vjmax}	I_{Fpulse}			360	A
Power dissipation	P_{tot}		T_C = 25 °C	375	W
			T_C = 100 °C	170	

Table 5   **Characteristic values**

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Diode forward voltage	V_F	I_F = 120 A	T_{vj}=25 °C		1.7	1.95	V
			T_{vj}=175 °C		1.74		
Diode reverse recovery charge	Q_{rr}	V_R<470 V, R_{Gon}=4.8 Ω	T_{vj} = 25 °C, I_F = 120 A, $-di_F/dt$ = 1070 A/µs		3.6		µC
			T_{vj} = 175 °C, I_F = 120 A, $-di_F/dt$ = 1055 A/µs		5.3		

(table continues...)

Table 5   (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Diode peak reverse recovery current	I_{rrm}	V_R<470 V, R_{Gon}=4.8 Ω	T_{vj} = 25 °C, I_F = 120 A, $-di_F/dt$ = 1070 A/µs		33		A
			T_{vj} = 175 °C, I_F = 120 A, $-di_F/dt$ = 1055 A/µs		43		
Reverse recovery energy	E_{rec}	V_R<470 V, V_{GE} = -8/15 V, R_{Gon}=4.8 Ω, L_σ = 50 nH, C_σ = 30 pF	T_{vj} = 25 °C, I_F = 120 A, $-di_F/dt$ = 1070 A/µs		1.2		mJ
			T_{vj} = 175 °C, I_F = 120 A, $-di_F/dt$ = 1055 A/µs		1.6		
Diode thermal resistance, junction to case[1]	R_{thjc}				0.31	0.4	K/W
Operating junction temperature	T_{vj}			-40		175	°C

[1]   Note subject to test

4 Characteristics diagrams

Power dissipation as a function of case temperature, IGBT

$P_{tot} = f(T_C)$

$T_{vj} \leq 175\ °C$
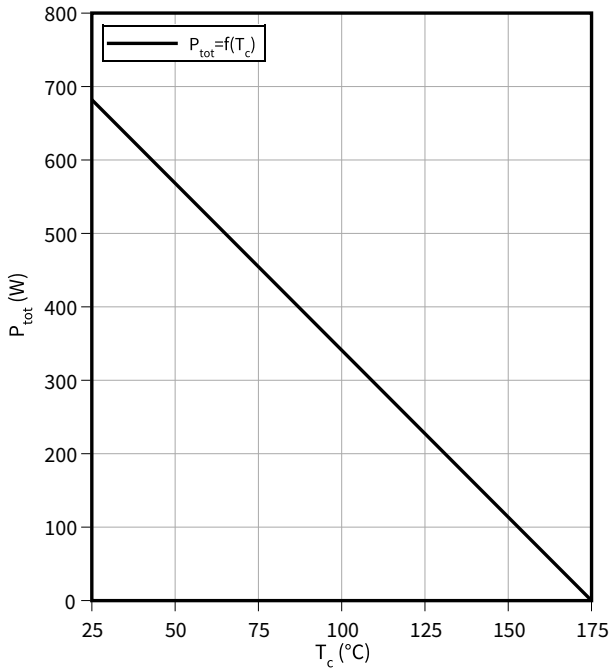
Collector current as a function of case temperature, IGBT

$I_C = f(T_C)$

$T_{vj} \leq 175\ °C,\ V_{GE} = 15\ V$
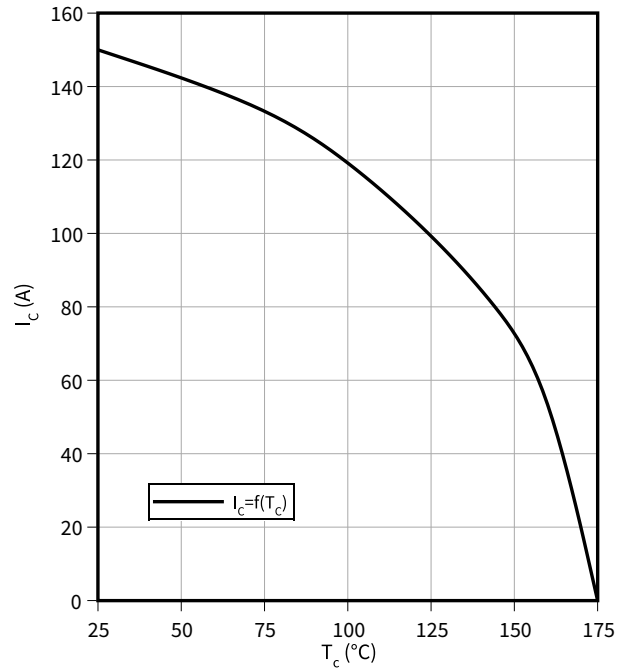
Typical output characteristic, IGBT

$I_C = f(V_{CE})$

$T_{vj} = 25\ °C$
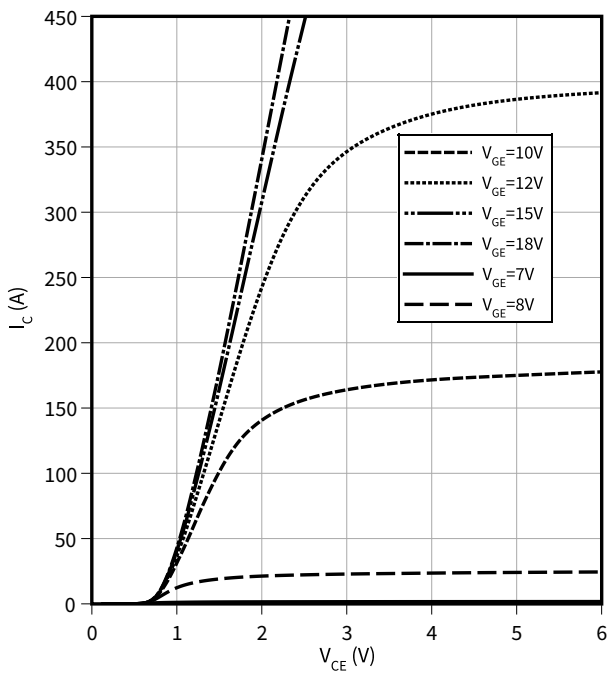
Typical output characteristic, IGBT

$I_C = f(V_{CE})$

$T_{vj} = =175\ °C$
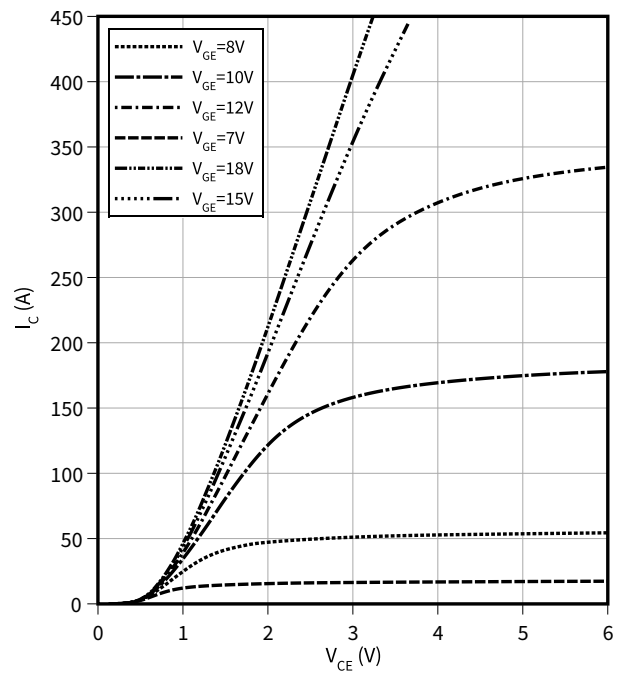
Typical transfer characteristic, IGBT

$I_C = f(V_{GE})$

$V_{CE} = 20$ V
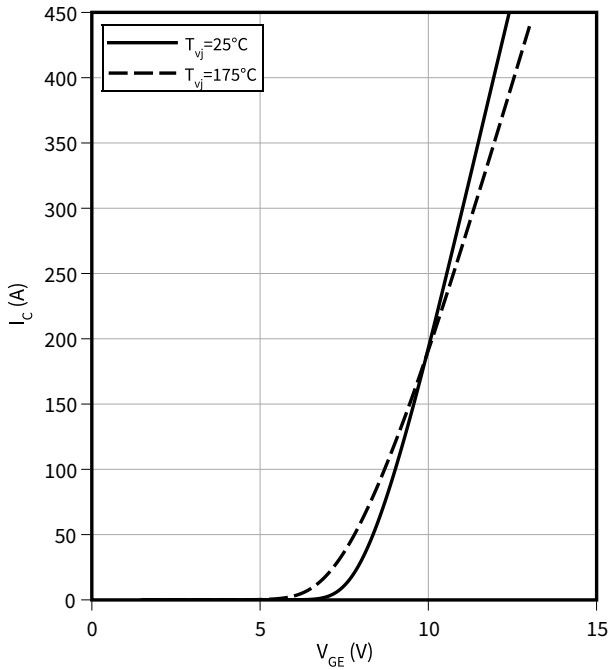
Typical collector-emitter saturation voltage as a function of junction temperature, IGBT

$V_{CEsat} = f(T_{vj})$

$V_{GE} = 15$ V
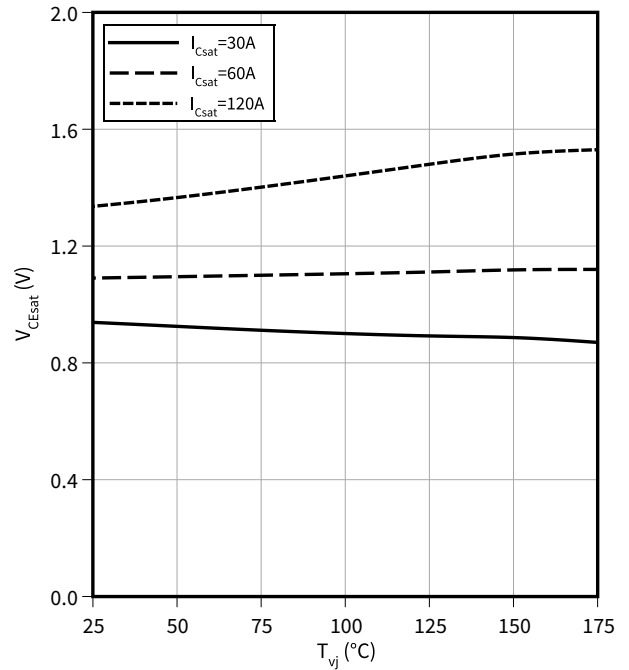
Typical switching times as a function of collector current, IGBT

$t = f(I_C)$

$R_{Goff} = 5.0$ Ω, $V_{CE} = 470$ V, $T_{vj} = 175$ °C, $V_{GE} = -8/15$ V, $R_{Gon} = 5$ Ω
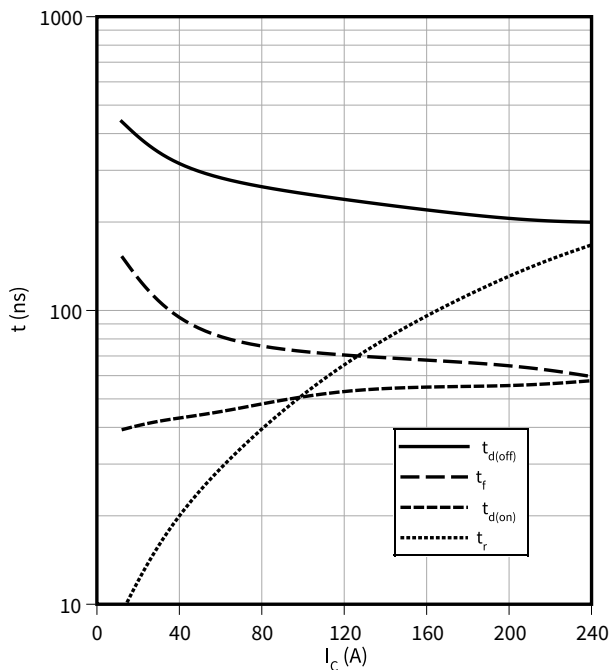
Typical switching times as a function of gate resistor, IGBT

$t = f(R_G)$

$I_C = 120.0$ A, $V_{CE} = 470$ V, $T_{vj} = 175$ °C, $V_{GE} = -8/15$ V

infineon

4 Characteristics diagrams
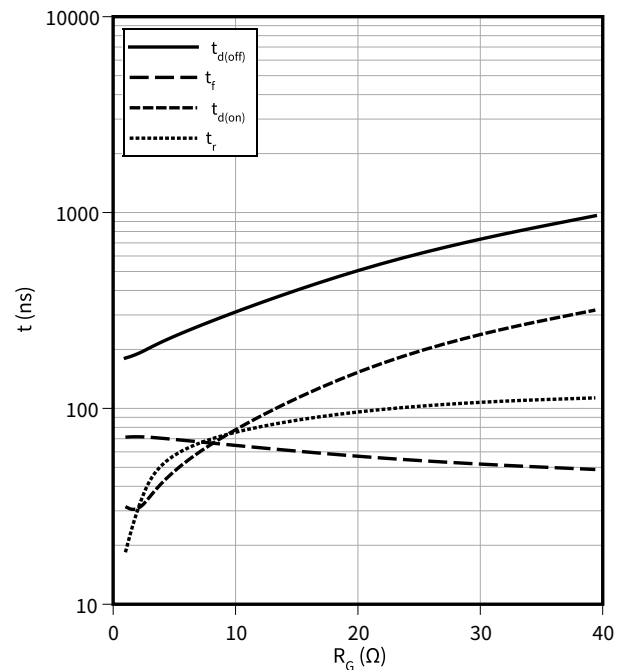
Typical switching times as a function of junction temperature, IGBT

$t = f(T_{vj})$

I_C = 120.0 A, R_{Goff} = 5.0 Ω, V_{CE} = 470 V, V_{GE} = -8/15 V, R_{Gon} = 5 Ω
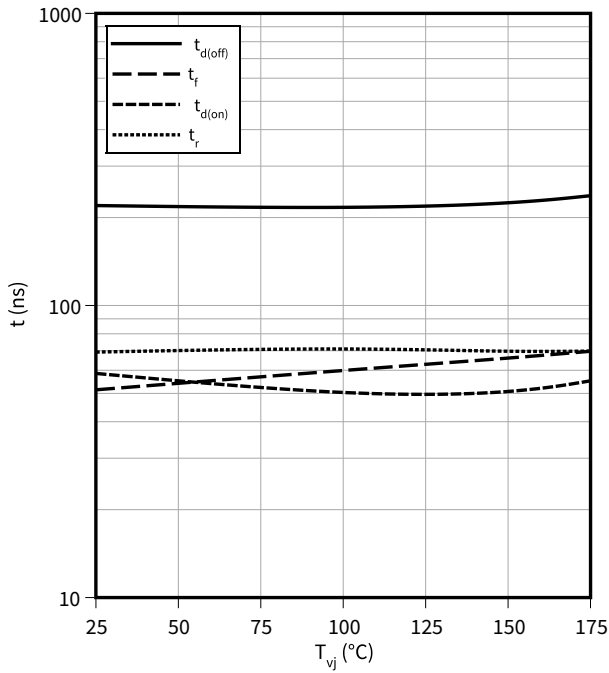
Typical Gate-emitter threshold voltage as a function of junction temperature, IGBT
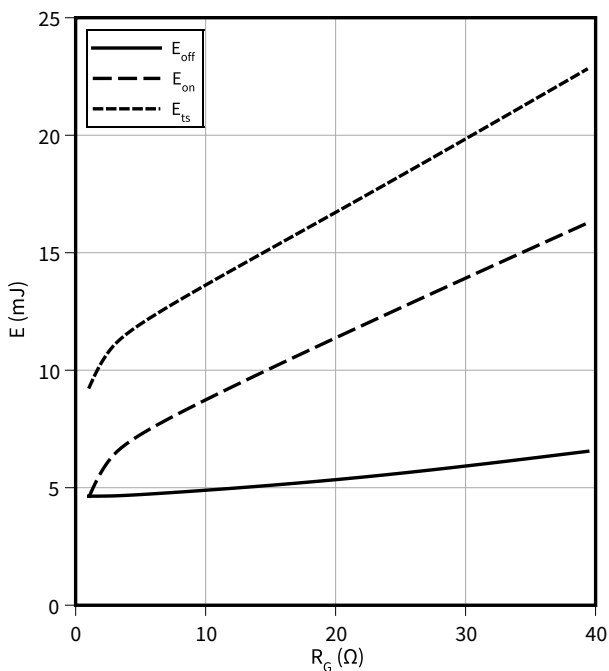
$V_{GEth} = f(T_{vj})$

I_C = 1.60 mA
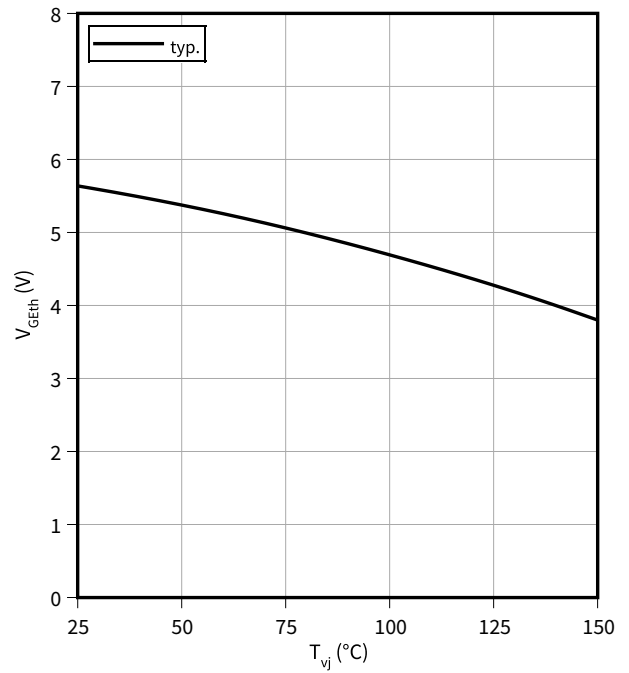
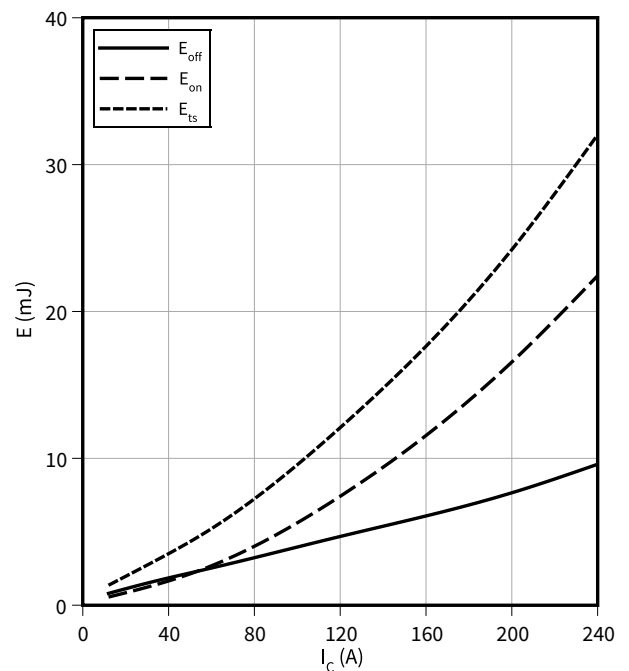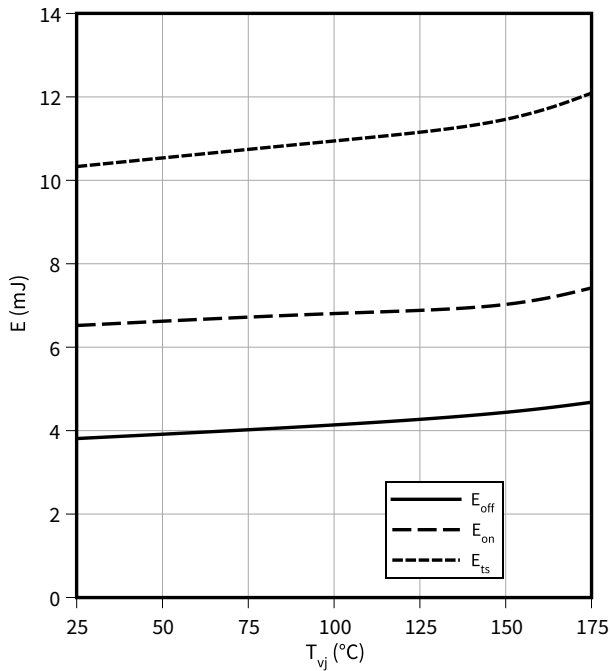**Typical switching energy losses as a function of gate resistor, IGBT**

$E = f(R_G)$

I_C = 120.0 A, V_{CE} = 470 V, T_{vj} = 175 °C, V_{GE} = -8/15 V

Typical switching energy losses as a function of collector current, IGBT

$E = f(I_C)$

R_{Goff} = 5.0 Ω, V_{CE} = 470 V, T_{vj} = 175 °C, V_{GE} = -8/15 V, R_{Gon} = 5 Ω

Typical switching energy losses as a function of junction temperature, IGBT

$E = f(T_{vj})$

$I_C = 120.0$ A, $R_{Goff} = 5.0$ Ω, $V_{CE} = 470$ V, $V_{GE} = -8/15$ V, $R_{Gon} = 5$ Ω

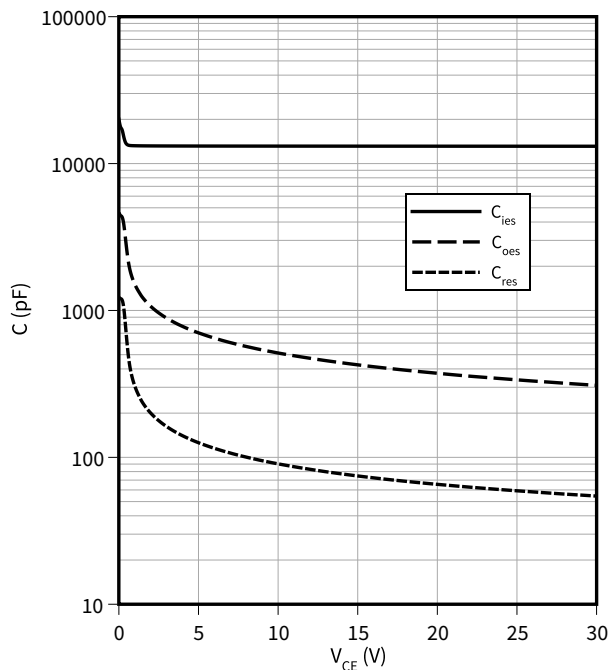**Typical switching energy losses as a function of collector emitter voltage, IGBT**

$E = f(V_{CE})$

$I_C = 120$ A, $R_{Goff} = 5$ Ω, $T_{vj} \leq 175$ °C, $V_{GE} = -8/15$ V, $R_{Gon} = 5$ Ω
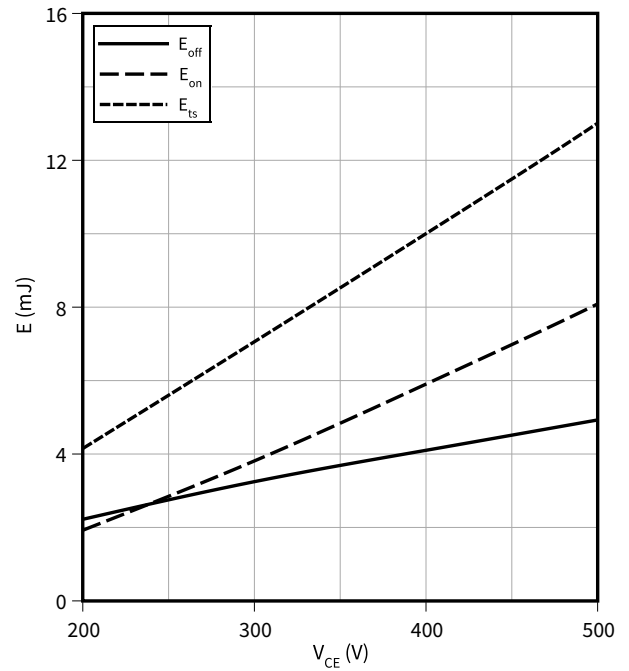
Typical capacitance as a function of collector-emitter voltage, IGBT

$C = f(V_{CE})$

$f = 100$ kHz, $V_{GE} = 0$ V
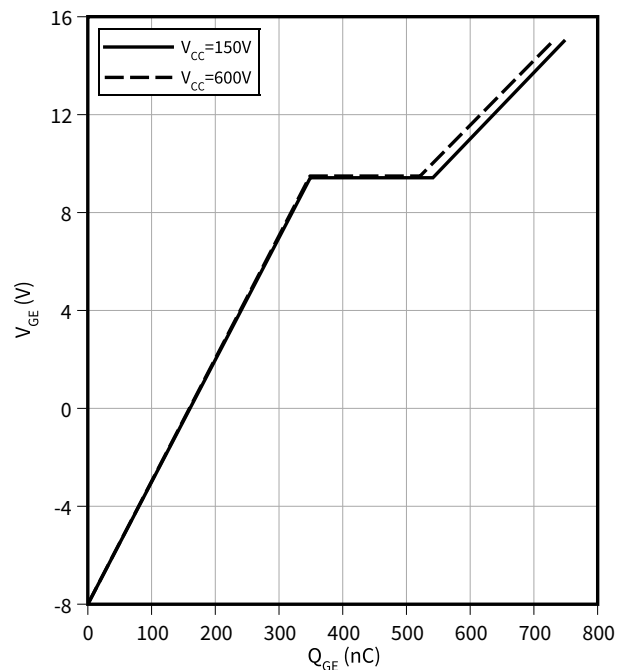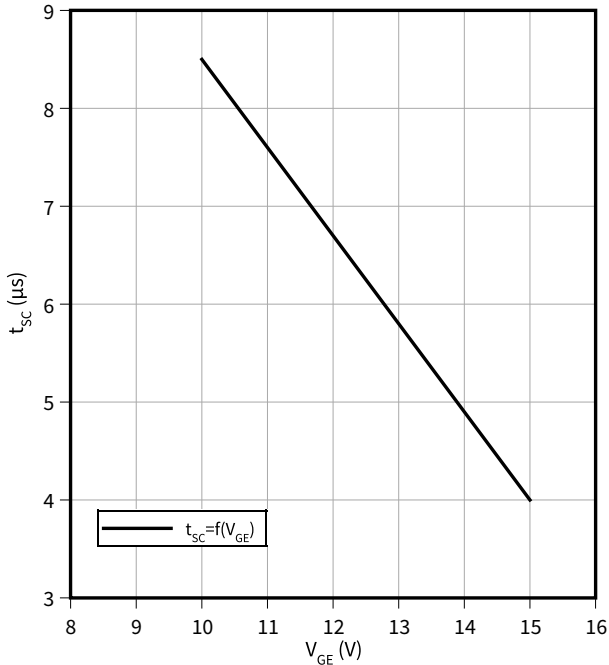

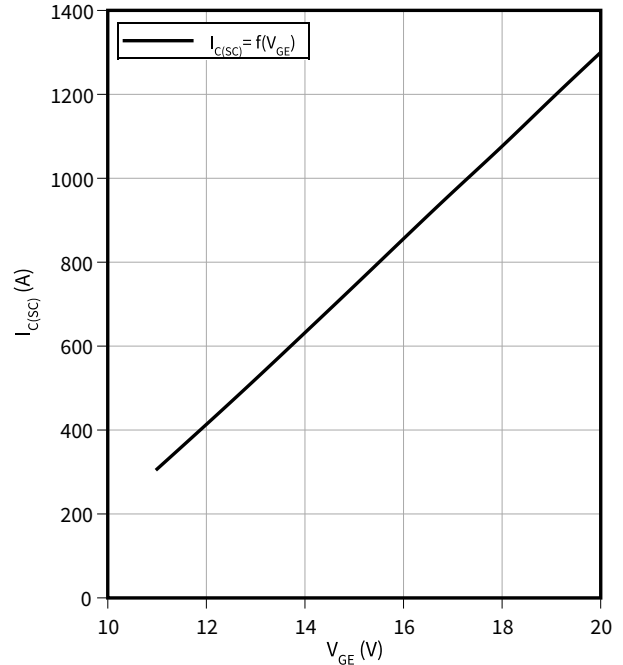**Typical gate charge, IGBT**

$V_{GE} = f(Q_{GE})$

$I_C = 120.0$ A

Typical Short circuit withstand time as a function of gate-emitter voltage, IGBT
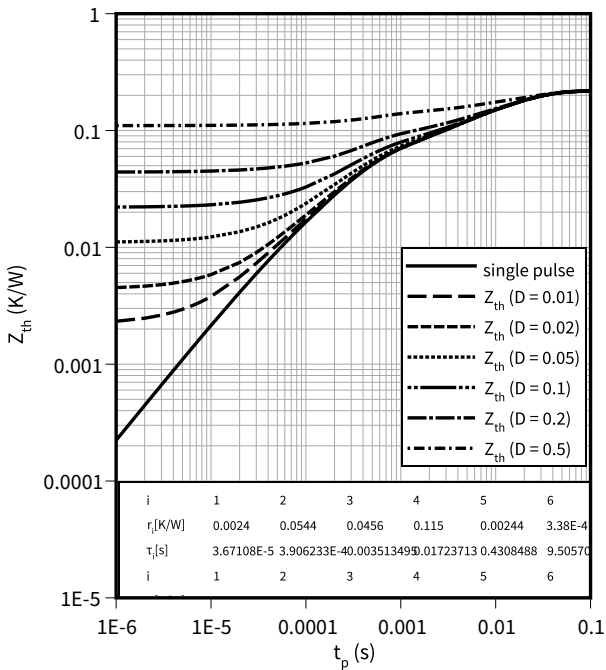
$t_{SC} = f(V_{GE})$

$T_{vj} \le 175\ °C$, $V_{CC} \le 470\ V$

Typical short circuit collector current as a function of gate-emitter voltage, IGBT

$I_{C(SC)} = f(V_{GE})$

$T_{vj} \le 175\ °C$, $V_{CC} \le 470\ V$

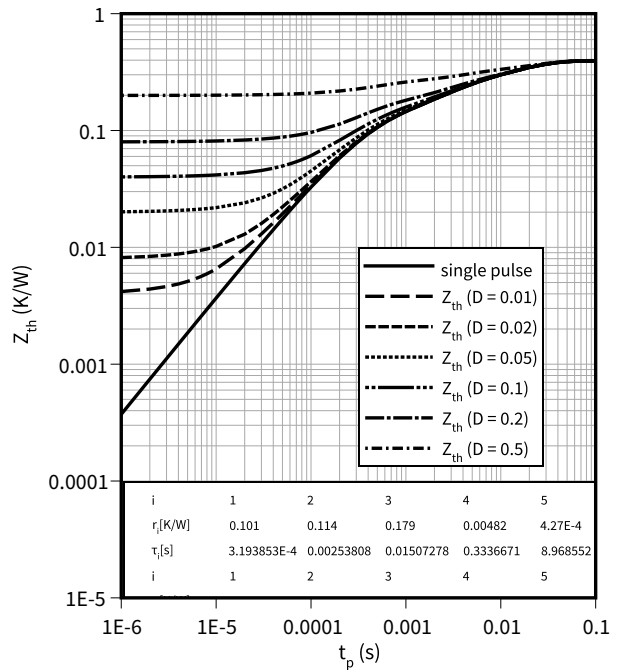**IGBT transient thermal impedance as a function of pulse width, IGBT**

$Z_{th} = f(t_p)$

$D = t_p/T$

i	1	2	3	4	5	6
r_i[K/W]	0.0024	0.0544	0.0456	0.115	0.00244	3.38E-4
τ_i[s]	3.67108E-5	3.906233E-4	0.003513495	0.01723713	0.4308488	9.50570
i	1	2	3	4	5	6

Diode transient thermal impedance as a function of pulse width, Diode

$Z_{th} = f(t_p)$

$D = t_p/T$

i	1	2	3	4	5
r_i[K/W]	0.101	0.114	0.179	0.00482	4.27E-4
τ_i[s]	3.193853E-4	0.00253808	0.01507278	0.3336671	8.968552
i	1	2	3	4	5

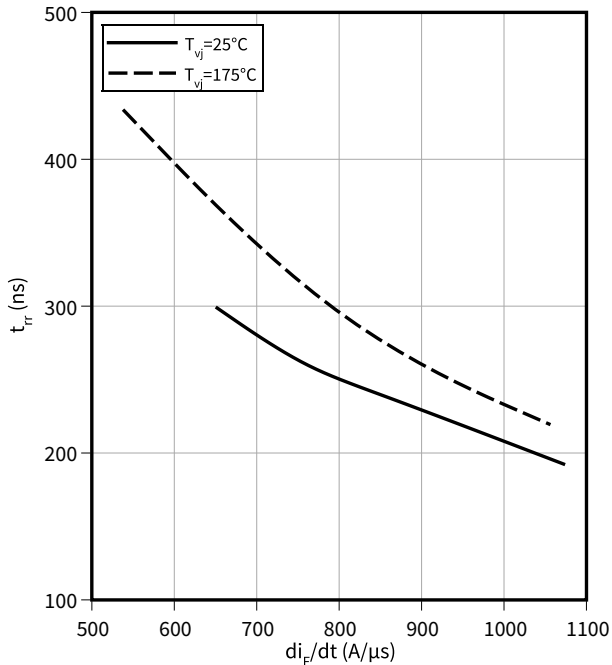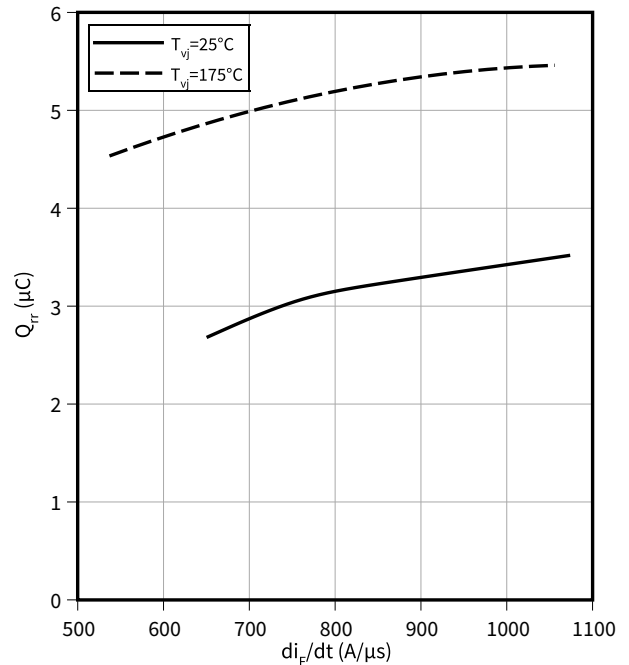**Typical reverse recovery time as a function of diode current slope, Diode**

$t_{rr} = f(di_F/dt)$

$V_R = 470$ V, $I_F = 120.0$ A

Typical reverse recovery charge as a function of diode current slope, Diode
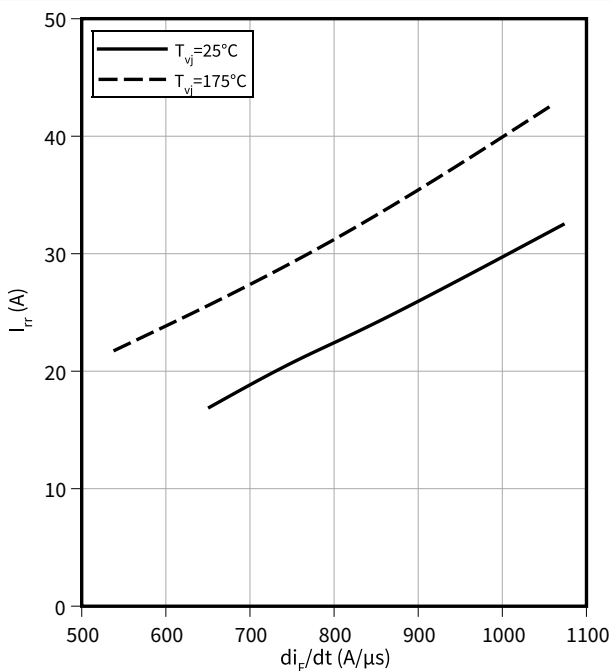
$Q_{rr} = f(di_F/dt)$

$V_R = 470$ V, $I_F = 120.0$ A

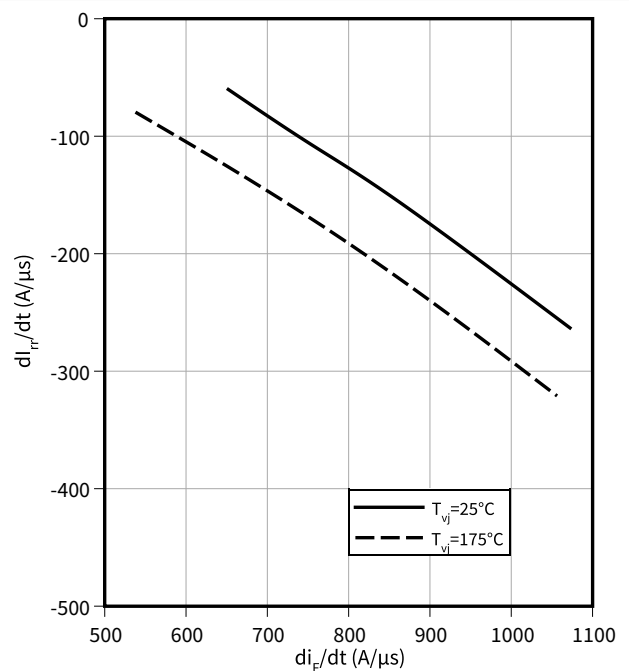**Typical reverse recovery current as a function of diode current slope, Diode**

$I_{rr} = f(di_F/dt)$

$V_R = 470$ V, $I_F = 120.0$ A

Typical diode peak rate of fall of reverse recovery current as a function of diode current slope, Diode

$dI_{rr}/dt = f(di_F/dt)$

$V_R = 470$ V, $I_F = 120.0$ A
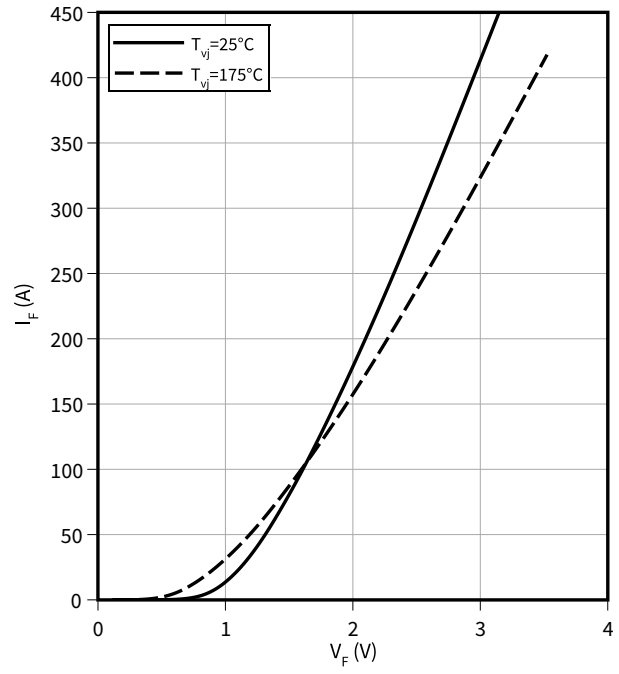
4 Characteristics diagrams

Typical diode forward voltage as a function of junction temperature, Diode	**Typical diode forward current as a function of forward voltage, Diode**
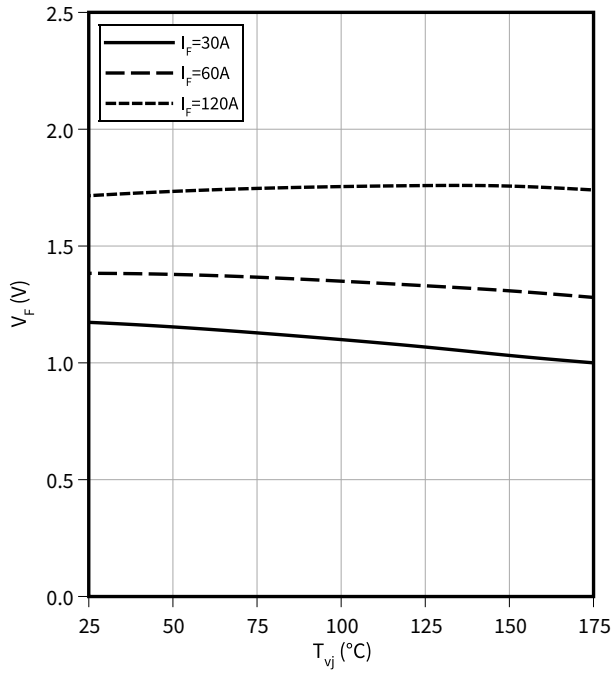
$V_F = f(T_{vj})$

$I_F = f(V_F)$

5   Package outlines

Package Drawing PG-TO247PLUS-3
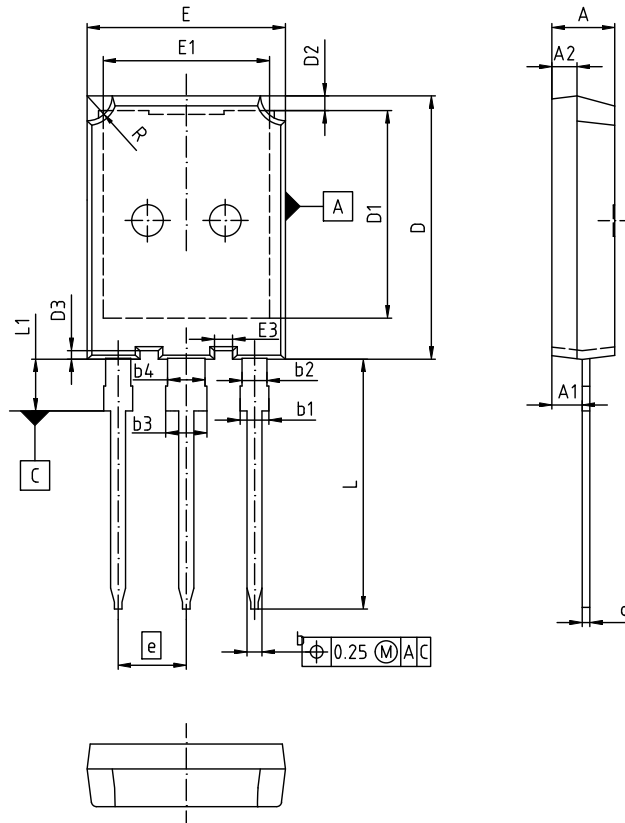
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.201
A1	2.31	2.51	0.091	0.099
A2	1.90	2.10	0.075	0.083
b	1.16	1.26	0.046	0.050
b1	1.96	2.25	0.077	0.089
b2	1.96	2.06	0.077	0.081
c	0.59	0.66	0.023	0.026
D	20.90	21.10	0.823	0.831
D1	16.25	16.85	0.640	0.663
D2	1.05	1.35	0.041	0.053
D3	0.58	0.78	0.023	0.031
E	15.70	15.90	0.618	0.626
E1	13.10	13.50	0.516	0.531
E3	1.35	1.55	0.053	0.061
e	5.44 (BSC)		0.214 (BSC)	
N	3		3	
L	19.80	20.10	0.780	0.791
L1	-	4.30	-	0.169
R	1.90	2.10	0.075	0.083

DOCUMENT NO.
Z8B00174295

SCALE

EUROPEAN PROJECTION

ISSUE DATE
13-08-2014

REVISION
01

Figure 1

Revision history

Document revision	Date of release	Description of changes
1.00	2022-02-16	Final datasheet
1.10	2022-03-16	Updated VF and Rthjc